TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC7PA175FU

### D-Type Flip-Flop with Clear

### **Features**

- Operating voltage range: V<sub>CC</sub> = 1.8 to 3.6 V
- High-speed operation:  $t_{pd}$  = 3.5 ns (max) at  $V_{CC}$  = 3.0 to 3.6 V

 $t_{pd}$  = 4.6 ns (max) at  $V_{CC}$  = 2.3 to 2.7 V

 $t_{pd}$  = 9.2 ns (max) at  $V_{CC}$  = 1.8 V

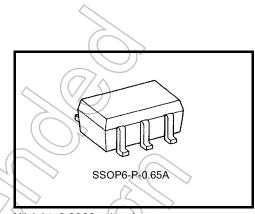
· High-level output current:

 $I_{OH}/I_{OL}$  = ±24 mA (min) at  $V_{CC}$  = 3.0 V

 $I_{OH}/I_{OL}$  = ±18 mA (min) at  $V_{CC}$  = 2.3 V

 $I_{OH}/I_{OL}$  = ±6 mA (min) at  $V_{CC}$  = 1.8 V

- 3.6-V tolerant inputs
- 3.6-V power down protection output

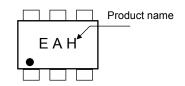


Weight: 0.0068 g (typ.)

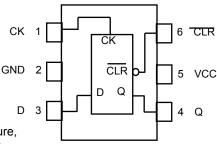
# Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	-0.5 to 4.6	V
DC input voltage	V <sub>IN</sub>	-0.5 to 4.6	>
		-0.5 to 4.6 (Note 1)	
DC output voltage	Vout	-0.5 to V <sub>CC</sub> + 0.5	$\sqrt{\lambda}$
		(Note 2)	
Input diode current	// lik	-50	mA
Output diode current	) Jok	-50 (Note 3)	mA
DC output current	lout	±50	mA
Power dissipation	P <sub>D</sub> <	200	mW
DC V <sub>CC</sub> /ground current	Icc	±100	mA
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Marking



## Pin Assignment (top view)



Note:

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating

temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

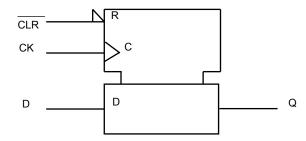
Note 1:  $V_{CC} = 0 V$ 

Note 2: High or Low state. The I<sub>OUT</sub> absolute maximum rating must be adhered to.

Note 3: V<sub>OUT</sub> < GND

Start of commercial production 2003-07

# **IEC Logic Symbol**



## **Truth Table**

	INPUTS		OUTPUT	FUNCTION
CLR	D	СК	Q	FUNCTION
L	Х	Х	L	CLEAR
Н	L	4	L	-
Н	Н	1	Н	- (
Н	Х	ightharpoons	Qn	NO CHANGE

X: Don't care

# **Operating Ranges**

Characteristics	Symbol	Rating		Unit
Supply voltage	Vec	1.8 to 3.6 1.2 to 3.6 (Note 4)		V
Input voltage	VIN	-0.3 to 3.6		
Output voltage	Vout	0 to 3.6	(Note 5)	V
	7 1001	0 to V <sub>CC</sub>	0 to V <sub>CC</sub> (Note 6)	•
	(-	±24	(Note 7)	
Output Current	I <sub>OH</sub> /I <sub>OL</sub>	±18	(Note 8)	mA
	_	±6	(Note 9)	
Operating temperature	Topr	-40 to 85		°C
Input rise and fall time	d <sub>t</sub> /d <sub>v</sub>	0 to 10	(Note 10)	ns/V

Note 4: Data retention only

Note 5:  $V_{CC} = 0 \text{ V}$ 

Note 6: High or Low state

Note 7:  $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$ 

Note 8:  $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$ 

Note 9:  $V_{CC} = 1.8 \text{ V}$ 

Note 10:  $V_{\mbox{\footnotesize{IN}}} = 0.8$  to 2.0 V,  $V_{\mbox{\footnotesize{CC}}} = 3.0$  V

# DC Electrical Characteristics (Ta = -40 to $85^{\circ}$ C, 2.7 V < $V_{CC} \le 3.6$ V)

Characteristics	Symbol	Test C		Min	Max	Unit	
Characteristics	Symbol	rest c	V <sub>CC</sub> (V)	IVIIII	IVIAX	Offic	
High-Level Input Voltage	V <sub>IH</sub>		_	2.7 to 3.6	2.0	_	V
Low-Level Input Voltage	V <sub>IL</sub>		_	2.7 to 3.6	_	0.8	v
High-Level Output Voltage V <sub>OH</sub>			I <sub>OH</sub> = -100 μA	2.7 to 3.6	V <sub>CC</sub> - 0.2	_	
	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub>	I <sub>OH</sub> = -12 mA	2.7	2.2	_	
			$I_{OH} = -18 \text{ mA}$	3.0	2.4	_	
			$I_{OH} = -24 \text{ mA}$	3.0	2.2		V
			I <sub>OL</sub> = 100 μA	2.7 to 3.6	_	0.2	
Low-Level Output Voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 12 mA	2.7	_	0.4	
Low-Level Output Voltage	VOL	VIN — VIH OI VIL	I <sub>OL</sub> = 18 mA	3.0		0.4	
			I <sub>OL</sub> = 24 mA	3.0	17	0.55	
Input Leakage Current	I <sub>IN</sub>	$V_{IN} = 0$ to 3.6 V	V <sub>IN</sub> = 0 to 3.6 V		7-/	>±5.0	μΑ
Power-off Leakage Current	I <sub>OFF</sub>	V <sub>IN</sub> , V <sub>OUT</sub> = 0 to 3.6 V		0	7 <i>H</i>	10.0	μА
Quiescent Supply Current	loo	V <sub>IN</sub> = V <sub>CC</sub> or GND		2.7 to 3.6		20.0	
	Icc	$V_{CC} \le (V_{IN}, V_{OUT}) \le 3.6 \text{ V}$		2.7 to 3.6	<b>Y</b> —	±20.0	μΑ
Increase in I <sub>CC</sub> per Input	Δl <sub>CC</sub>	$V_{IH} = V_{CC} - 0.6 V$	Ĭ	2.7 to 3.6	_	750	

# DC Electrical Characteristics (Ta = -40 to $85^{\circ}$ C, 2.3 V $\leq$ V<sub>CC</sub> $\leq$ 2.7 V)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Max	Unit
High-Level Input Voltage	(VIH))		+/	2.3 to 2.7	1.6	_	V
Low-Level Input Voltage	VIL			2.3 to 2.7	_	0.7	V
		(7/4)	t <sub>OH</sub> = -100 μA	2.3 to 2.7	V <sub>CC</sub> - 0.2		
High-Level Output Voltage	VoH	VIN = VIH	$I_{OH} = -6 \text{ mA}$	2.3	2.0		
			I <sub>OH</sub> = -12 mA	2.3	1.8	_	
$\rightarrow$			I <sub>OH</sub> = -18 mA	2.3	1.7	_	V
			$I_{OL} = 100 \mu A$	2.3 to 2.7	_	0.2	
Low-Level Output Voltage	VOL	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 12 mA	2.3	_	0.4	
	91		I <sub>OL</sub> = 18 mA	2.3	_	0.6	
Input Leakage Current	TIN	V <sub>IN</sub> = 0 to 3.6 V		2.3 to 2.7	_	±5.0	μА
Power-off Leakage Current	loff	V <sub>IN</sub> , V <sub>OUT</sub> = 0 to 3.6 V		0	_	10.0	μА
Quiggant Supply Current	loo	V <sub>IN</sub> = V <sub>CC</sub> or GNE	)	2.3 to 2.7	_	20.0	^
Quiescent Supply Current	Icc	V <sub>CC</sub> ≤ (V <sub>IN</sub> , V <sub>OUT</sub>	r) ≤ 3.6 V	2.3 to 2.7	_	±20.0	μА

# DC Electrical Characteristics (Ta = -40 to $85^{\circ}$ C, $1.8 \text{ V} \leq \text{V}_{\text{CC}} < 2.3 \text{ V}$ )

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Max	Unit
High-Level Input Voltage	V <sub>IH</sub>	_		1.8 to 2.3	0.7 × V <sub>CC</sub>		V
Low-Level Input Voltage	V <sub>IL</sub>	_		1.8 to 2.3		0.2 × V <sub>CC</sub>	V
High-Level Output Voltage	Voн	V <sub>OH</sub> V <sub>IN</sub> = V <sub>IH</sub>	I <sub>OH</sub> = -100 μA	1.8	VCC 0.2		
g. = a a a a a a a a a a a a a a a a a a			I <sub>OH</sub> = -6 mA	7/1,8	1.4	_	V
Low-Level Output Voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>II</sub>	I <sub>OL</sub> = 100 μA	1.8	_	0.2	
Low-Level Output Voltage	VOL	VIN - VIH OI VIL	I <sub>OL</sub> = 6 mA	1.8		0.3	
Input Leakage Current	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 3.6 V		1.8	)	±5.0	μΑ
Power-off Leakage Current	l <sub>OFF</sub>	V <sub>IN</sub> , V <sub>OUT</sub> = 0 to 3.6 V		0		10.0	μΑ
Quiescent Supply Current	Icc	$V_{IN} = V_{CC}$ or GNE		1.8	1	20.0	μА
Quicocon Supply Surrent	icc	V <sub>CC</sub> ≤ (V <sub>IN</sub> , V <sub>OUT</sub>	)≤3.6 V	1.8	)}-	±20.0	μΛ

# AC Electrical Characteristics (Ta = -40 to 85°C, input $t_r = t_f = 2.0$ ns, $C_L = 30$ pF, $R_L = 500 \Omega$ )

					_	
Characteristics	Symbol	Test Condition	/V <sub>CC</sub> (V)	Min	Max	Unit
			1.8	100	_	
Maximam Clock Frequency	f <sub>max</sub>		2.5 ± 0.2	200	_	MHz
			3.3 ± 0.3	250	_	
Propagation Delay Time			1.8	1.0	9.2	
( CK-Q )	t <sub>pLH</sub>	(Figure 1 and 2)	$2.5\pm0.2$	8.0	4.6	ns
(CK-Q)	VPHL V		$3.3\pm0.3$	0.6	3.5	
Propagation Delay Time	7/6		1.8	1.0	9.2	
(CLR-Q)	tpHL	(Figure 1 and 3)	$2.5\pm0.2$	0.8	4.6	ns
	7 <		$3.3\pm0.3$	0.6	3.5	
			1.8	3.0	_	
Minimum Set-up Time	ts	(Figure 1 and 2)	$2.5\pm0.2$	1.5	_	ns
			$3.3\pm0.3$	1.5	_	
	$\langle \rangle$	*	1.8	3.0	_	
Minimum Hold time	th	(Figure 1 and 2)	$2.5\pm0.2$	1.7	_	ns
			$3.3 \pm 0.3$	1.7	_	
Minimun Pulse Width	t <sub>w</sub> (H)		1.8	4.0	—	
(CK)	t <sub>w</sub> (L)	(Figure 1 and 2)	$2.5 \pm 0.2$	2.3	—	ns
(GIV)	W(L)		$3.3 \pm 0.3$	2.3	—	
Minimun Pulse Width			1.8	4.0	_	
( CLR )	t <sub>w</sub> (L)	(Figure 1 and 3)	$2.5\pm0.2$	2.3	_	ns
			$3.3\pm0.3$	2.3	_	
			1.8	3.1	_	
Minimum Removal Time	t <sub>rem</sub>	(Figure 1 and 3)	$2.5\pm0.2$	2.0	_	ns
			$3.3 \pm 0.3$	1.5		

For  $C_L = 50 \ pF$ , add approximately 300 ps to the AC maximum specification.

# **Capacitive Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Тур.	Unit	
Input Capacitance	C <sub>IN</sub>		_		1.8, 2.5, 3.3	2.4	pF
Power Dissipation Capacitance	C <sub>PD</sub>	f <sub>IN</sub> = 10 MHz		(Note 11)	1.8, 2.5, 3.3	11	pF

Note11: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

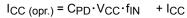


Figure 1 Test Circuit

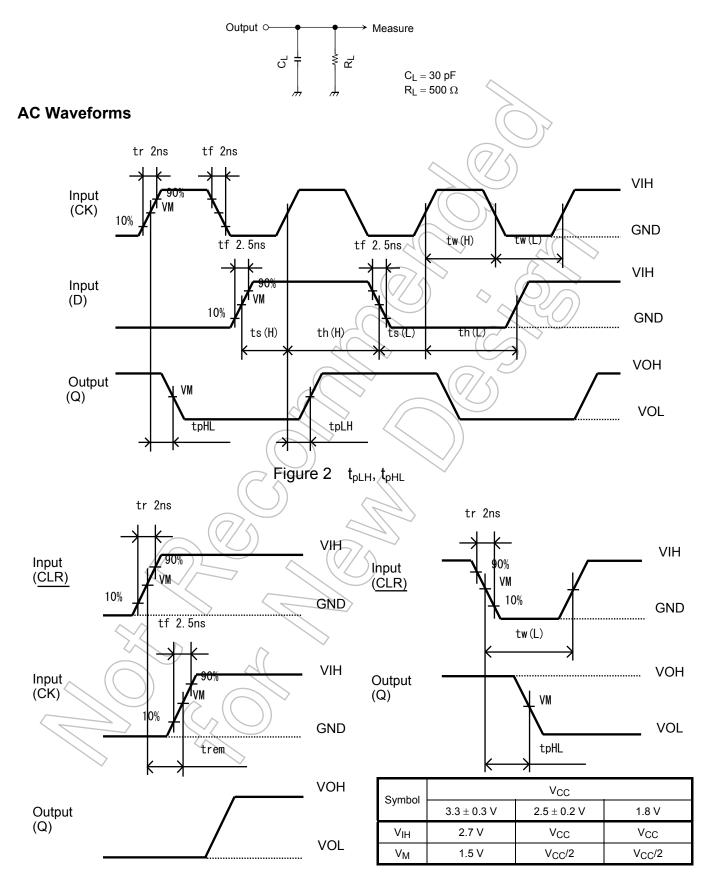
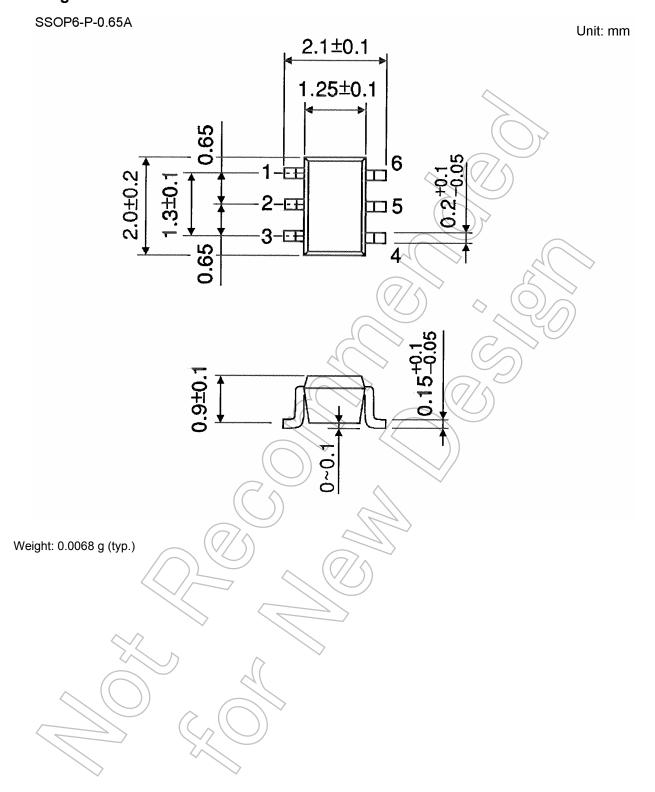


Figure 3  $t_{rem}$ ,  $t_{pHL}$ ,  $t_w(L)$ 

6



# **Package Dimensions**



#### RESTRICTIONS ON PRODUCT USE

- Toshiba Corporation, and its subsidiaries and affiliates (collectively "TOSHIBA"), reserve the right to make changes to the information in this document, and related hardware, software and systems (collectively "Product") without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE
  EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH
  MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT
  ("UNINTENDED USE"). Except for specific applications as expressly stated in this document, Unintended Use includes, without
  limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, equipment used for
  automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions,
  safety devices, elevators and escalators, devices related to electric power, and equipment used in finance-related fields. IF YOU USE
  PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT. For details, please contact your
  TOSHIBA sales representative.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any
  applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE
  FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY
  WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR
  LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND
  LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO
  SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS
  FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.
  Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES
  OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

8

2014-03-01